

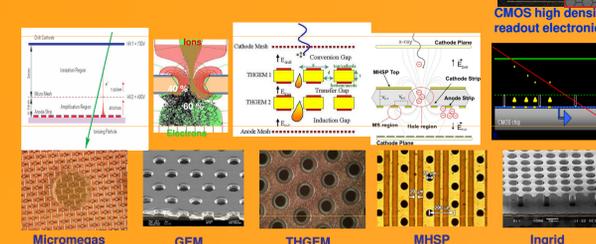
RD51 Collaboration: Development of Micro-Pattern Gaseous Detectors technologies

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Current Trends in MPGD: Technologies

The Micro-Strip Gas Chamber, introduced by Oed in 1988 (NIMA 263, 351), was the first Micro-Pattern Gaseous Detector; exploiting photolithography techniques for the production of micrometric structure of electrodes, this family of gaseous detectors led to significant improvements in terms of rate capability and spatial resolution with respect to the Multi-Wire Proportional Chambers.

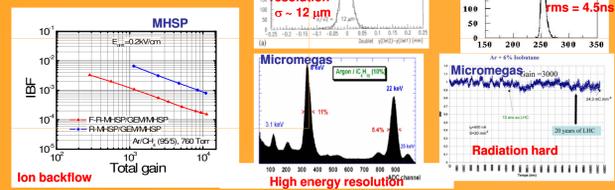
After 20 years, MPGD technologies are well established. Beside well-known representatives, such as GEM (Gas Electron Multiplier, F. Sauli, NIMA A386 (1997), 531) and Micromegas (Micro Mesh Gaseous Structure, Y. Giomataris, NIMA 419 (1998), 239), other examples of current R&D on technologies are: Thick-GEM, Micro Hole & Strip Plates and other hole-type detectors; structures with resistive electrodes; the integration of the MPGD with CMOS pixel ASICs or the production of the two in the same process as in the case of Ingrid



Current Trends MPGD: Performance

MPGDs can be optimized in order to achieve challenging performance in terms of:

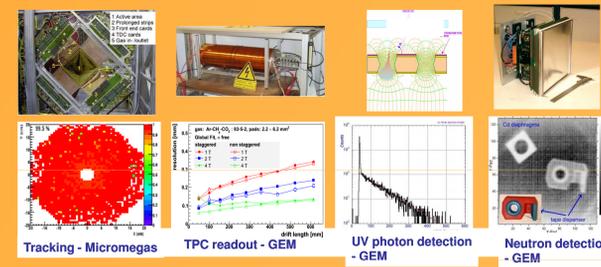
- Rate Capability
- High Gain
- Space Resolution
- Time Resolution
- Energy Resolution
- Ageing Properties
- Ion Backflow Reduction
- Photon Feedback Reduction



Current Trends in MPGD: Applications

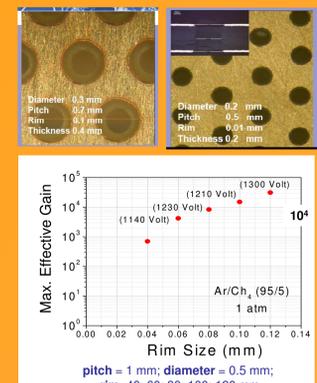
COMPASS experiment at CERN has been the first application of GEM and Micromegas detectors and MPGD are also present in the apparatus of LHC experiments (LHCb and TOTEM). Actually applications range in High Energy physics environment as well as other fields:

- High-Rate Particle Tracking and Triggering
- Time Projection Chamber Readout
- Photon Detectors for Cherenkov Imaging Counters
- X-Ray Astronomy
- Neutron Detection and Low Background Experiments
- Cryogenic Detectors
- Medical Applications
- Homeland Security and Prevention of Planetary Disasters



WG1: Detector design optimization – Thick GEM rim example

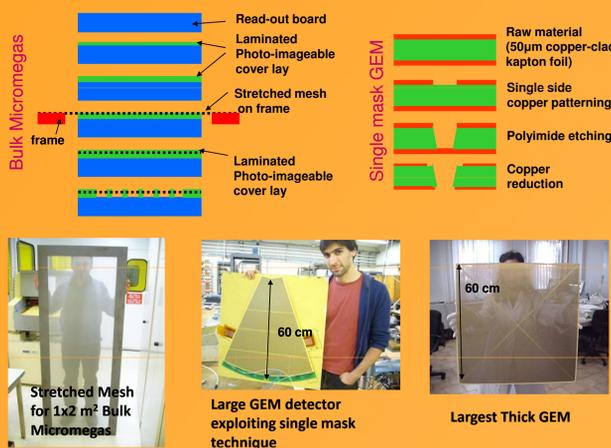
A Thick GEM is a copper-clad fiberglass layer with a matrix of holes realized by means of mechanical drilling and, in some cases, chemical etching. Typical dimension are sub-millimetric.



The introduction of a rim on the two copper layers is effective for the increase of the maximum achievable gain. On the other hand, due to the larger dielectric surface exposed to the charges produced in the avalanche, a larger rim shows also larger and longer charging-up effects, increasing the time to arrive to a stable operation

WG1: Large area MPGD

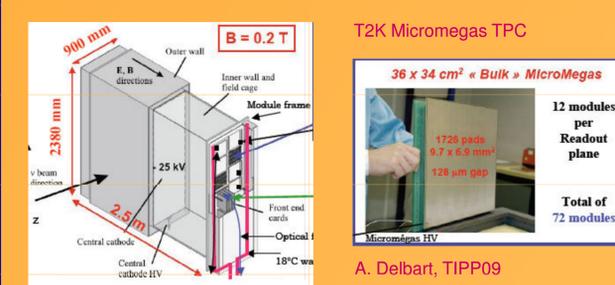
Limitations in MPGD size can come from the production technique or the available instrumentations and raw material. New production techniques can overcome these limitations and open the way to larger detectors, as in the case of bulk micromegas and single mask GEM foils



organization in 7 Working Group

WG1	WG2	WG3	WG4	WG5	WG6	WG7
MPGD Technology & New Structures	Characterization	Applications	Software & Simulation	Electronics	Production	Common Test Facilities
Design optimization, Development of new geometries and techniques	Common test standards, Characterization and understanding of physical phenomena in MPGD	Evaluation and optimization for specific applications	Development of common software and documentation for specific applications	Readout electronics optimization and integration with MPGD detectors	Development of cost-effective technologies and industrialization	Sharing of common infrastructure for detector characterization
Large Area MPGDs	Common Test Standards	Tracking and Triggering, Photon Detection, Calorimetry	Algorithms, Simulation improvements	FE electronics requirements definition, General Purpose Pixel Chip	Common Production Facility	Testbeam Facility
Design Optimization, New Geometries, Fabrication	Discharge Protection, Ageing & Radiation Hardness	Cryogenic Detectors, X-Ray and Neutron Imaging	Common Platform (Root, Geant4)	Large Area Systems with Pixel Readout	Industrialization	Irradiation Facility
Development of Rad-Hard Detectors	Charging up and Rate Capability	Astroparticle Phys. as Appl., Medical Applications	Electronic Modeling	Portable Multi-Channel System	Collaboration with Industrial Partners	
Development of Portable Detectors	Study of Austenitic Steels	Synchrotron Rad., Plasma Diagn., Jernisland Sec.		Discharge Protection Strategies		

WG3: Tracking and triggering applications

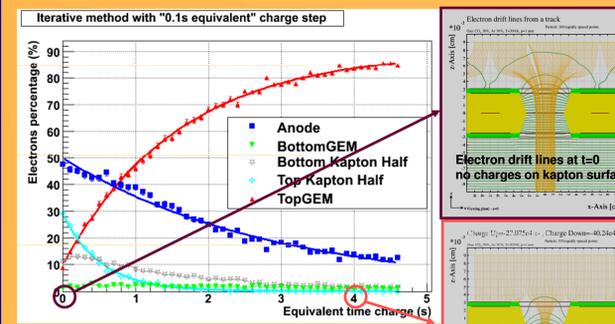


WG4: Simulation improvements

New features have been introduced or are under way in Garfield, the main software for gas detector simulation, in order to take into account the smaller scale of MPGD technologies:

- a new algorithm for microscopic electron tracking and avalanche
- the introduction of Penning transfer mechanism
- the introduction of a Boundary Element Solver (NeBEM) for field calculations
- the integration of Garfield in common platforms such as ROOT and Geant4

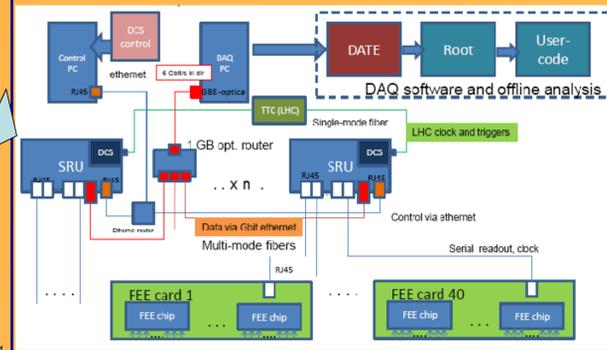
WG4: Charging-up simulation



Discrepancies in GEM detectors simulation with respect to measurements can be explained by the charging-up of the dielectric. Studies are under way to include this dynamic process in the simulation.

WG5: Multi-channel Readout System

The development of a multi-channel scalable (from small test system to very large LHC-like system) are under way. A special effort is dedicated to make it compatible to the largest possible set of current Front-End Electronics used in gaseous detectors



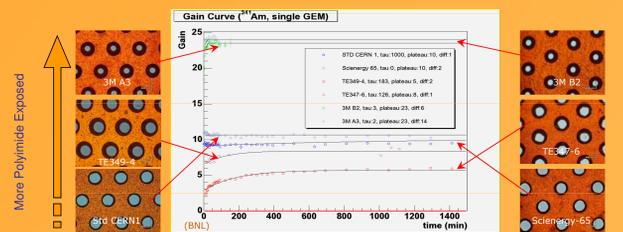
WG6: Common Production facilities

One of the main WG6 task is to promote the upgrade of the production facilities according to the requirements of the future applications

Detector Technology	Currently produced (cm * cm)	Future Requirements (cm * cm)
GEM	40 * 40	50 * 50
GEM, single mask	70 * 40	200 * 50
THGEM	70 * 50	200 * 100
RTHGEM, serial graphics	20 * 10	100 * 50
RTHGEM, Kapton	50 * 50	200 * 100
Micromegas, bulk	150 * 50	200 * 100
Micromegas, microbulk	10 * 10	30 * 30
MHSP (Micro-Hole and Strip Plate)	3*3	10*10

WG2: Charging-up and operation stability

Due to the presence of dielectric in MPGD geometries, charging-up phenomena must be studied to understand the stability over time of the detector. Different geometries or production process can lead to different behaviour.



WG2: Aging and radiation hardness

Construction components validation, such as glues and materials, is crucial for radiation hard detectors.

Source	Product	Outgas	Effect in G.D.	Result
CERN/GDD	ARALDITE AW 106 (Hardener HV 935 U)	YES		BAD
CERN/GDD	DURALCO 4525	YES	YES	BAD
CERN/GDD	DURALCO 4461	YES	YES	BAD
CERN/GDD	HEXCEL A40	YES		BAD
CERN/GDD	TECHNICOLL 8862 + (Hardener 8263)	YES		BAD
CERN/GDD	NORLAND NEA 155	YES		BAD
CERN/GDD	EPOTEK E905	YES		BAD
CERN/GDD	NORLAND NEA 123 (UV)	YES		BAD

WG7: Common test beam facility

RD51 is building up a semi-permanent test setup on the SPS/H4 beam line at CERN. Common infrastructures such as cables, gas pipes, gas mixing system, as well as common devices for trigger and tracking telescope, common DAQ and analysis software will reduce installation dead times and will avoid duplication of efforts and resources.

